

**ADVANCED CUSTOMIZED ECL (ACE)****ACE1320, ACE1400 & ACE2200****MASTER SLICE LOGIC ARRAYS****FEATURES**

- 3-micron geometry (first metal)
- Internal gate delays as low as 300 picoseconds (average gate delay of 450 picoseconds)
- Expandable 80-cell MACRO library
- Mask-selectable rise/fall times for I/O interface cells
- Bidirectional and TTL interfaces
- 10K/100K ECL compatibility
- Computer aided design (CAD) for layout, simulation, and testing
- Mature process (SUBILO P)
- Pin grid array packages for easy socket insertion
- 25-ohm and 50-ohm load drive capability

**PRODUCT DESCRIPTION**

The Signetics Advanced Customized ECL (ACE) family of products provides the user with a cost-effective technology, futuristic speeds, and other high-performance alternatives for the design of LSI-based systems. Basic cell designs are implemented with Emitter Coupled and Common Mode Logic (ECL/CML) to guarantee the very best compromise between speed, power, and interface capabilities—see Figure 1 and TECHNICAL SUMMARY that follows.

At present, the ACE product line is available with gate complements of 600, 900, 1320, 1400, and 2200; the 1320 array actually contains 1000 gates with an on-board 320-bit RAM.

The 1320/1400/2200 gate arrays, described in this data sheet, are particularly well suited for complex applications requiring relatively high gate counts and considerable design flexibility. To meet the flexibility requirements, the rise-and-fall times for I/C cells of these arrays are mask-selectable and bidirectional and TTL interfaces are standard.

All ACE arrays are I/O compatible with the 10K/100K ECL logic family and all are fabricated with a very mature process; thus, even with 3-micron first-metal geometry, first pass success is a virtual certainty. The speed-power product for devices in the ACE family is in the neighborhood of 1 to 3 picojoules, permitting heat-sink cooling at ambient air temperatures. The ACE family and MACRO library is alternately sourced by a major supplier of semicustom devices.

To summarize, the designer, using ACE, is limited only by innovation and imagination:

- ECL/CML Technology for SPEED and EFFICIENCY
- Mature process for PRODUCT CERTAINTY
- Computer aided design for QUICK DELIVERY
- Pin grid packages (socket insertion) for RELIABILITY
- Signetics for QUALITY

**ORDERING INFORMATION**

Contact Local Sales Representative

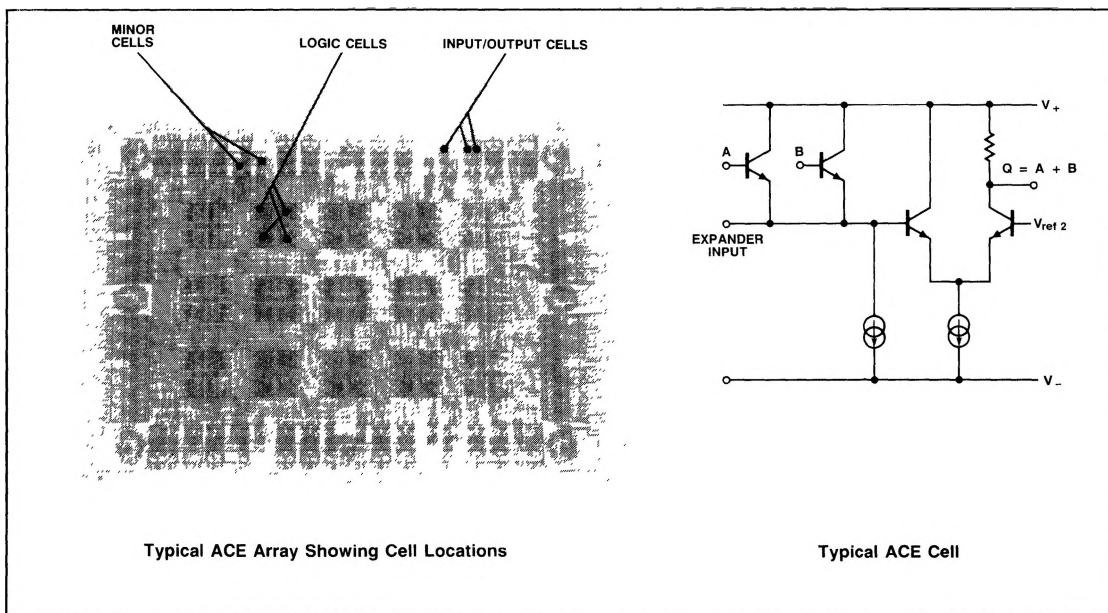


Figure 1. Chip Architecture and Typical Circuit

**ADVANCED CUSTOMIZED ECL (ACE)****ACE 1320, ACE 1400 & ACE 2200****MASTER SLICE LOGIC ARRAYS****TECHNICAL SUMMARY OF ACE FAMILY**

PARAMETER	ACE 600	ACE 900	ACE 1320	ACE 1400	ACE 2200
Major cells	24	36	48	60	100
Input/output cells	28	28	96	96	128
Input cells	30	42	—	—	—
Worst case noise margin	24 - 45 mV		24 - 45 mV		
Junction temperature range	30 - 125°C		30 - 125°C		
Average prop delay (internal gate)	0.3 - 0.5 ns		0.3 - 0.5 ns		
	10K LEVEL	100K LEVEL	10K LEVEL	100K LEVEL	
Power supply	-5.25V ± 5%	-4.5V ± 5%	-5.25V ± 5%	-4.5V ± 5%	
Power consumption	2.1 - 2.7 mW	1.8 - 2.3 mW	4.6 - 6.3 mW	4 - 5.5 mW	
ACE PACKAGE TYPE AND THERMAL RESISTIVITY SELECTION					
	PACKAGE	THERMAL RESISTIVITY (°C/W)			
		HEAT SINK	NO AIR FLOW	5 m/s AIR FLOW	
	ACE 600 & ACE 900	64 Pin	Yes	25	13
No			50	25	
ACE 1320, ACE 1400 & ACE 2200	144 Pin	Yes	12	6	
		No	24	12	